

Data Sheet January 2000 File Number 3371.3

80A, 1000V Ultrafast Diode

The RURG80100 is an ultrafast diode with soft recovery characteristics (t_{rr} < 125ns). It has low forward voltage drop and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimizes ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Formerly developmental type TA09887.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RURG80100	TO-247	RURG80100

NOTE: When ordering, use the entire part number.

Symbol



Features

Ultrafast with Soft Recovery	25ns
Operating Temperature	75 ⁰ C
Reverse Voltage	000V

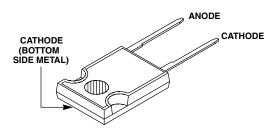
- · Avalanche Energy Rated
- Planar Construction

Applications

- · Switching Power Supplies
- · Power Switching Circuits
- · General Purpose

Packaging

JEDEC STYLE 2 LEAD TO-247



RURG80100

LIMITS

Absolute Maximum Ratings $T_C = 25^{\circ}C$, Unless Otherwise Specified

	nundouluu	UNITS
Peak Repetitive Reverse Voltage	1000	V
Working Peak Reverse Voltage	1000	V
DC Blocking VoltageV _R	1000	V
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 53^{\circ}C$)	80	Α
Repetitive Peak Surge CurrentIFRM (Square Wave, 20kHz)	160	Α
Nonrepetitive Peak Surge Current	500	Α
Maximum Power Dissipation	180	W
Avalanche Energy (See Figures 7 and 8)	50	mJ
Operating and Storage Temperature	-65 to 175	٥С

RURG80100

Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	ТҮР	MAX	UNITS
V _F	I _F = 80A	-	-	1.9	V
	I _F = 80A, T _C = 150°C	-	-	1.7	V
I _R	V _R = 1000V	-	-	250	μА
	$V_R = 1000V, T_C = 150^{\circ}C$	-	-	2	mA
t _{rr}	I _F = 1A, dI _F /dt = 100A/μs	-	-	125	ns
	$I_F = 80A$, $dI_F/dt = 100A/\mu s$	-	-	200	ns
ta	$I_F = 80A$, $dI_F/dt = 100A/\mu s$	-	90	-	ns
t _b	$I_F = 80A$, $dI_F/dt = 100A/\mu s$	-	65	-	ns
$R_{ heta JC}$		-	-	0.83	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of t_{a} + t_{b} .

 t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

Typical Performance Curves

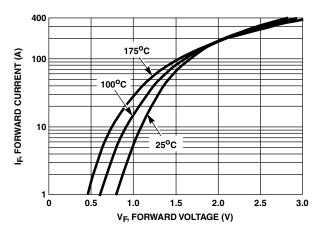


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

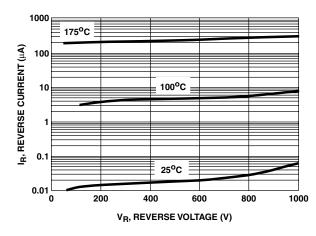


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

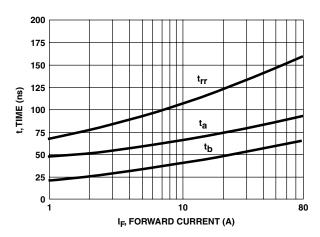


FIGURE 3. t_{rr} , t_a and t_b curves vs forward current

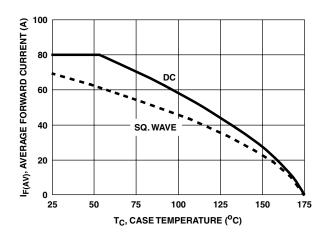


FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

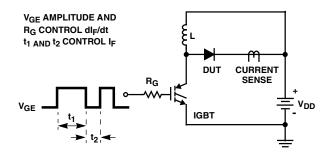


FIGURE 5. t_{rr} TEST CIRCUIT

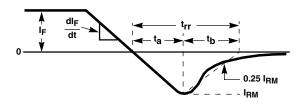


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

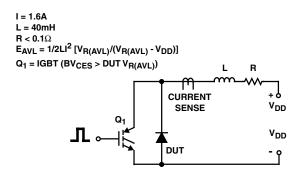


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

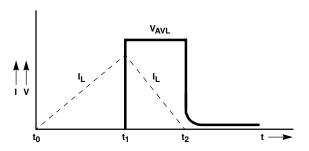


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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DenseTrench™	HiSeC™	QS™	TinyLogic™
DOME™	ISOPLANAR™	QT Optoelectronics™	UHC TM
EcoSPARK™	LittleFET™	Quiet Series™	UltraFET™
E ² CMOS TM	MicroFET™	SILENT SWITCHER ®	VCX^{TM}
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PRODUCT STATUS DEFINITIONS

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